

DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: **Method Of Forming A Thin Film Transistor**, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56.

**PRIOR FOREIGN APPLICATIONS:**

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

**POWER OF ATTORNEY:**

As a named Inventor, I hereby appoint the following attorneys and agent to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Richard J. St. John, Reg. No. 19,363; David P. Roberts, Reg. No. 23,032; Randy A. Gregory, Reg. No. 30,386; Mark S. Matkin, Reg. No. 32,268; James L. Price, Reg. No. 27,376; Deepak Malhotra, Reg. No. 33,560; Mark W. Hendrickson,

1 Reg. No. 32,356; David G. Latwesen, Reg. No. 38,533; George G.  
2 Grigel, Reg. No. 31,166; Keith D. Grzelak, Reg. No. 37,144; John S.  
3 Reid, Reg. No. 36,369; W. Bryan Farney, Reg. No. 32,651 and Lia M.  
4 Pappas, Reg. No. 34,095.

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7 WA 99204-0317. Direct telephone calls to: Mark S. Matkin,  
8 (509) 624-4276.

9 I hereby declare that all statements made herein of my own  
10 knowledge are true and that all statements made on information and  
11 belief are believed to be true; and further that these statements were  
12 made with the knowledge that willful false statements and the like so  
13 made are punishable by fine or imprisonment, or both, under  
14 Section 1001 of Title 18 of the United States Code and that such willful  
15 false statement may jeopardize the validity of the application or any  
16 patent issued therefrom.

17 \* \* \* \* \*

18 Full name of inventor: Gurtej S. Sandhu

19 Inventor's Signature: Gurtej S. Sandhu

20 Date: 1/17/96

21 Residence: Boise, Idaho

22 Citizenship: U.K.

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Full name of inventor: **Shubneesh Batra**

Inventor's Signature: Surmesh Jain

Date: 1/22/96

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Citizenship: **India**

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Full name of inventor: Pierre C. Fazan

Inventor's Signature: John D. Jones

Date: 11/19/96

Residence: Boise, Idaho

Citizenship: Switzerland

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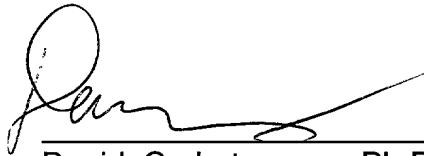
Assistant Commissioner for Patents

Washington, D.C. 20231

**ASSOCIATE POWER OF ATTORNEY**

Please recognize James D. Shaurette, Reg. No. 39,833; Frederick M. Fliegel, Reg. No. 36,138; Donald B. Kenady, Reg. No. 40,045; James E. Lake, Reg. No. 44,854; Bernard Berman, Reg. No. 37,279 and Jennifer J. Taylor, Reg. No. P-48,711, whose post office address is 601 W. First Avenue, Suite 1300, Spokane, Washington 99201-3828, as an associate attorney or agent in the above-entitled application.

Date: 7/9/01

  
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David G. Latwesen, Ph.D.  
Reg. No. 38,533

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